

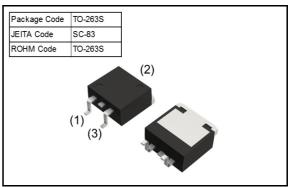
# **RB218NS200FH**

## Schottky Barrier Diode

(AEC-Q101 qualified) Data sheet

| $V_{R}$          | 200 | V |
|------------------|-----|---|
| Ι <sub>ο</sub>   | 20  | Α |
| I <sub>FSM</sub> | 100 | A |

#### Outline



FeaturesHigh reliability

Power mold type

Cathode common dual type

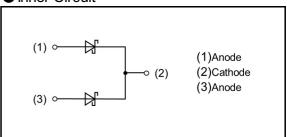
Super Low I<sub>R</sub>

ApplicationSwitching power supply

● Structure

Silicon epitaxial planar

Inner Circuit



Packaging Specifications

| Packing          | Embossed Tape |  |  |  |  |
|------------------|---------------|--|--|--|--|
| Reel Size(mm)    | 330           |  |  |  |  |
| Taping Width(mm) | 24            |  |  |  |  |
| Quantity(pcs)    | 1000          |  |  |  |  |
| Taping Code      | TL            |  |  |  |  |
| Marking          | RB218NS200    |  |  |  |  |

● Absolute Maximum Ratings (T<sub>c</sub>=25°C unless otherwise specified)

| Parameter                         | Symbol           | Conditions                                                                                     | Limits           | Unit |
|-----------------------------------|------------------|------------------------------------------------------------------------------------------------|------------------|------|
| Repetitive peak reverse voltage   | V <sub>RM</sub>  | Duty≦0.5                                                                                       | 200              | V    |
| Reverse voltage                   | V <sub>R</sub>   | Reverse direct voltage                                                                         | 200              | V    |
| Average rectified forward current | lo               | 60Hz half sin waveform, resistive load, I <sub>0</sub> /2 per diode, T <sub>c</sub> =115°cMax. | 20               | А    |
| Peak forward surge current        | I <sub>FSM</sub> | 60Hz half sin waveform,<br>non-repetitive, per diode, T <sub>a</sub> =25°c                     | 100              | А    |
| Junction temperature              | Tj               | -                                                                                              | 150              | င    |
| Storage temperature               | T <sub>stg</sub> | -                                                                                              | -55 <b>~</b> 150 | ဇ    |

#### Attention

Compared with PN junction diodes, Schottky Barrier Diode is generally high reverse current (IR). The reverse loss of the diode might increase as temperature increasing that causes heat-up and further IR. This phenomenon might end up the thermal destruction (thermal runaway). Therefore please give consideration to the reverse loss and the ambient temperature when using this product.

RB218NS200FH Data sheet

## ● Electrical Characteristics (T<sub>j</sub>=25°C unless otherwise specified)

| Parameter                      | Symbol         | Conditions           | Min. | Тур. | Max. | Unit |
|--------------------------------|----------------|----------------------|------|------|------|------|
| Forward voltage <sup>(1)</sup> | V <sub>F</sub> | I <sub>F</sub> =10A  | -    | -    | 0.88 | V    |
| Reverse current <sup>(1)</sup> | I <sub>R</sub> | V <sub>R</sub> =200V | -    | -    | 10   | μA   |

Note (1) Value per diode

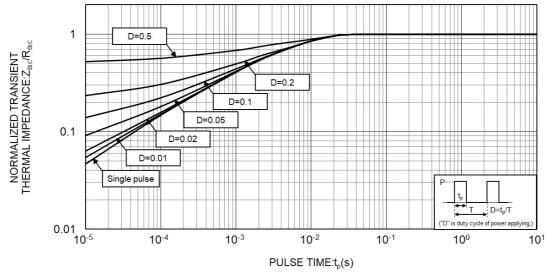
## Thermal Characteristics

| Parameter                                                   |            | Symbol             | Min. | Тур. | Max. | Unit |
|-------------------------------------------------------------|------------|--------------------|------|------|------|------|
| Thermal Resistance (Junction to case) <sup>(1) (2)</sup>    | Per diode  | - R <sub>θJC</sub> | -    | -    | 1.1  | °C/W |
|                                                             | Per device |                    | -    | -    | 0.61 | °C/W |
| Thermal Resistance (Junction to ambient) <sup>(1)</sup> (3) |            | $R_{\theta JA}$    | -    | -    | 55   | °C/W |

Notes (1) Value is guaranteed by design.

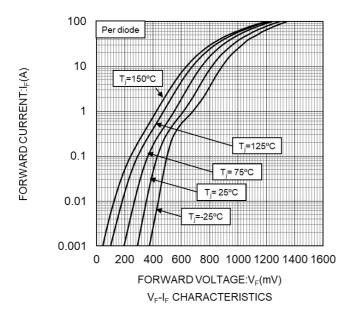
- (2) Transient dual interface measurement (TDIM) method.
- (3) Mounted on 50 x 50 x 1.6mm FR4 board, single-sided copper, 35µm thickness, reference footprint.

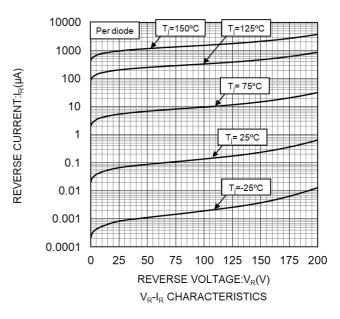
## Characteristic Curves

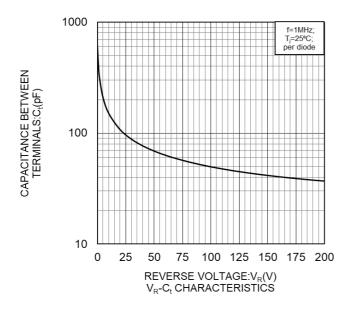


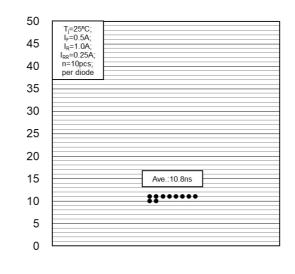
NORMALIZED TRANSIENT THERMAL IMPEDANCE FROM JUNCTION TO CASE (PER DEVICE)

## Characteristic Curves





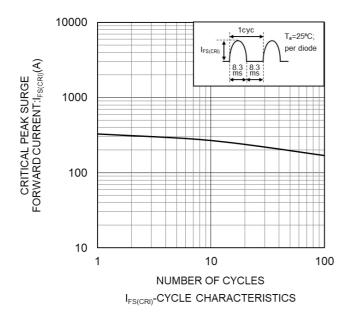


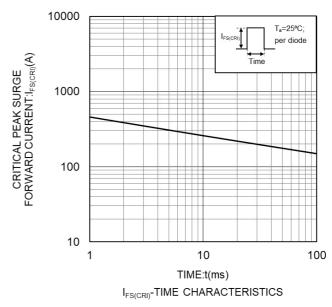


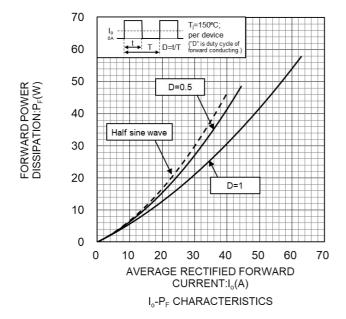
trr DISPERSION MAP

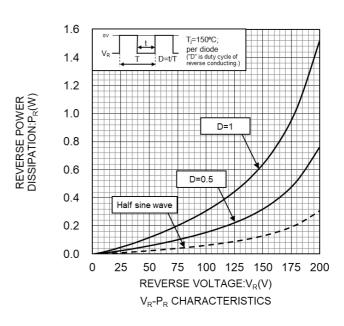
REVERSE RECOVERY TIME:tr(ns)

## Characteristic Curves

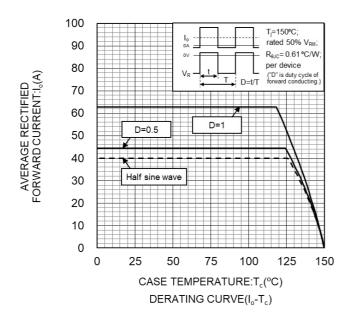




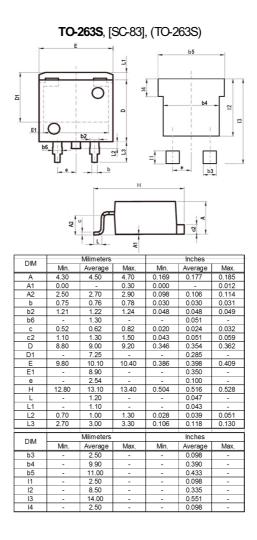




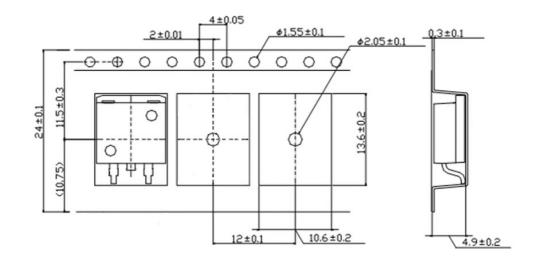
## Characteristic Curves



## Dimensions



## ● Taping (Unit:mm)



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(Note1) Medical Equipment Classification of the Specific Applications

| ľ | JÁPAN   | USA    | EU         | CHINA   |
|---|---------|--------|------------|---------|
| Γ | CLASSⅢ  | СГУССШ | CLASS II b | СГУССШ  |
|   | CLASSIV | CLASSⅢ | CLASSIII   | CLASSII |

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  - [f] Sealing or coating our Products with resin or other coating materials
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- 4. The Products are not subject to radiation-proof design.
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- 7. De-rate Power Dissipation depending on ambient temperature. When used in sealed area, confirm that it is the use in the range that does not exceed the maximum junction temperature.
- 8. Confirm that operation temperature is within the specified range described in the product specification.
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For details, please refer to ROHM Mounting specification

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This Product is electrostatic sensitive product, which may be damaged due to electrostatic discharge. Please take proper caution in your manufacturing process and storage so that voltage exceeding the Products maximum rating will not be applied to Products. Please take special care under dry condition (e.g. Grounding of human body / equipment / solder iron, isolation from charged objects, setting of lonizer, friction prevention and temperature / humidity control).

#### **Precaution for Storage / Transportation**

- 1. Product performance and soldered connections may deteriorate if the Products are stored in the places where:
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  - [b] the temperature or humidity exceeds those recommended by ROHM
  - [c] the Products are exposed to direct sunshine or condensation
  - [d] the Products are exposed to high Electrostatic
- Even under ROHM recommended storage condition, solderability of products out of recommended storage time period
  may be degraded. It is strongly recommended to confirm solderability before using Products of which storage time is
  exceeding the recommended storage time period.
- 3. Store / transport cartons in the correct direction, which is indicated on a carton with a symbol. Otherwise bent leads may occur due to excessive stress applied when dropping of a carton.
- 4. Use Products within the specified time after opening a humidity barrier bag. Baking is required before using Products of which storage time is exceeding the recommended storage time period.

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